

Order Code: Gas Discharge Tube

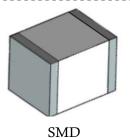
Version: A1

BC091N

Features

- Small Size Design EIA 1812 4.5×3.2×2.7mm
- Current Handling Capability 2,000A @ 8/20 μ s
- Low Capacitance and Insertion Loss
- Fast Response and Long Service Life
- Reliable to Protect Electrostatic Surge
- Moisture sensitivity level: Level 1

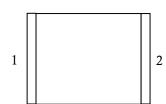
Exterior



Application information

- Coaxial

Package (Top View)



Agency Approvals

Icon	Description
RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003
6	Mean lead free

Schematic Symbol



Electrical Parameter

DC Breakdown Voltage 1)2)	100V/s	63-117	
Impulse Spark-over Voltage	At 1kV/µs	for 99 % of measured values ≤ 650	V
impuise spark-over voitage	At 1kV/µs	Typical values of distribution ≤ 550	V
	$8/20\mu s, \pm 5 times$	2,000	
Impulse Discharge Current 3)	8/20us, \pm 50times	100	A
	$10/1000$ us, ± 50 times	10	
AC Discharge Current	50Hz, 1S, 10times	2	A
Arc Voltage	At 1A	~8	V
Insulation Resistance	DC=50V	≥1	GΩ
Capacitance at 1 MHz	VDC=0.5V	≤0.5	pF
Weight		~0.20	g
Operating And Storage Temperature		-40-90	$^{\circ}$
Marking		Without	

- 1) At delivery AQL 0.65 level II ISO 2859 2) In ionized mode
- 3) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21





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Gas Discharge Tube

Version: A1 2016-06-2.

Part Numbering System

BC 091 N

(1) (2) (3)

- (1)Bencent Gas Discharge Tube
- (2) Series: DC Breakdown Voltage, e.g.: 091=9×10¹=90V
- (3) Tolerance of DC Breakdown Voltage, M=+-20%,

N=+-30%, the Specific tolerance is decided by the table of

Product Characteristics

Lead Material	Copper or iron nickel alloy
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

Environmental Reliability Characteristics

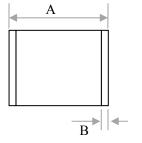
Testing items	Technical standards	
High Temperature Storage Test	Temperature: 90°C Time:2H	
Low Temperature Storage Test	Temperature: -40°C Time:2H	
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45mins	
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 1time	

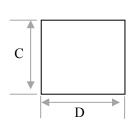
Note: Up-screen program can be specified by customer's request via contacting Bencent service

Solderability test

Solderability	Solder Pot Temperature:	245°C ±5°C
	Solder Dwell Time:	4-6 seconds

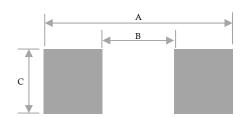
Product Dimensions





REF	mm	inch
A	4.5±0.3	0.177±0.012
В	0.5±0.2	0.020±0.008
С	2.7±0.2	0.106±0.008
D	3.2±0.2	0.126±0.008

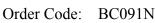
Recommended Soldering Pad



REF	mm	inch
A	5.5	0.217
В	3.5	0.138
С	3.5	0.138

[&]quot;Electrical Parameter"





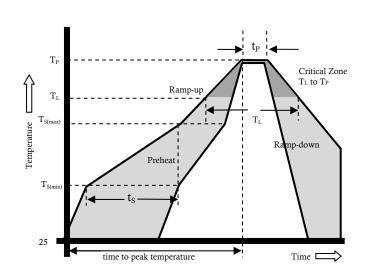
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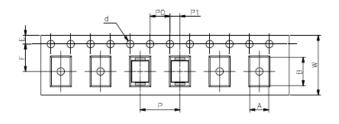
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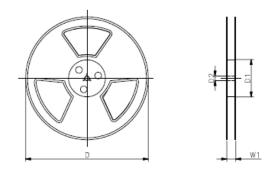
Reflow Profile

	Reflow Condition	Pb-Free assembly	
	Temperature Min	150°C	
Pre	Temperature Max	200°C	
Heat	Time (min to max)	60 – 180 secs	
Average ramp up rate (Liquids) Tamp (T_L) to peal		3°C/second max	
T _S (max) t	o T _L - Ramp-up Rate	3°C/second max	
Reflow	- Temperature (T _L) (Liquids)	217°C	
	- Temperature (T _L)	60 – 150 seconds	
Peak Tem	perature (T _P)	260+0/-5 °C	
Time with	nin 5°C of actual peak ure (tp)	8 – 20 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not ex	ceed	260°C	



Package Reel Information





REF	mm inch			
A	3.7±0.2	0.146±0.008		
В	4.7±0.2	0.185±0.008		
d	Ф1.5±0.1	Ф0.059±0. 004		
Е	1.75±0.1	0.069±0.004		
F	5.5±0.1	0.217±0.002		
P	8.0±0.1	0.315±0.004		
P0	4.0±0.1	0.157±0.004		
P1	2.0±0.1 0.079±0.004			
W	12.0±0.2	0.472±0.008		
D	Ф330.0	Ф13.0		
D1	Φ50Min Φ1.97Min			
D2	Φ13±0.15	0.512±0.006		
W1	16.8±2.0 0.661±0.079			

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)	CARTON SIZE(mm)		
				L	W	Н
TAPING	2,000	32,000	330	360	360	380